IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mf	als and Mfg Information				
Supplie	r Information														
Company	name*	Company unique ID				Unique ID Authority					Response Date*				
onsemi												2025-06-06			
Contact N	lame		Title - Contact				Phone - Contact*				Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	ate Version Manufacturing Sit		uring Site	Weight*		UOM	Unit Type	
		HCPL26	30M	8PW 10MB 2-CH DIP			2025-06-06			тнн		4	73.871	mg	Each
Manufa	cturing Proccess Informat	tion													
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD-020 N		-STD-020 MSI	L Rating	Peak Process Body Temperate		ture Max Time at Peak Temper		Temperatu	ire Numb	per of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed		CU Alloy NA		NA.		0 C		30		seconds 3				
Comments	3			·		·					·				·
				<u> </u>		·					·				·
or more	information regarding material	composition	please refer to	page 3										·	

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight Unit of Measure Level Substance		Substance	CAS	Exempt	Weight	Unit of Measure	
Coupling Gel	4.37	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.437	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		3.933	mg
Die	3.753	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.263	mg
			Supplier	Silicon (Si)	7440-21-3		3.49	mg
Die Attach	0.423	mg	Supplier	Silver (Ag)	7440-22-4		0.3173	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.1058	mg
Lead Frame	117.616	mg	Supplier	Silver (Ag)	7440-22-4		0.74	mg
			Supplier	Zinc (Zn)	7440-66-6		0.141	mg
			Supplier	Iron (Fe)	7439-89-6		2.7	mg
			Supplier	Copper (Cu)	7440-50-8		114	mg
			Supplier	Phosphorus (P)	7723-14-0		0.035	mg
Mold Compound-Black	ack 343.7	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		13.7	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		68.7001	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		10.3	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		250.9999	mg
Plating	3.81	mg	Supplier	Tin (Sn)	7440-31-5		3.81	mg
Wire Bond - Au	0.199	mg	Supplier	Gold (Au)	7440-57-5		0.199	mg